

1. Overview for the Stratix IV Device Family

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Altera® Stratix® IV FPGAs deliver a breakthrough level of system bandwidth and power efficiency for high-end applications, allowing you to innovate without compromise. Stratix IV FPGAs are based on the Taiwan Semiconductor Manufacturing Company (TSMC) 40-nm process technology and surpass all other high-end FPGAs, with the highest logic density, most transceivers, and lowest power requirements.

The Stratix IV device family contains three optimized variants to meet different application requirements:

- Stratix IV E (Enhanced) FPGAs—up to 813,050 logic elements (LEs), 33,294 kilobits (Kb) RAM, and 1,288 18 x 18 bit multipliers
- Stratix IV GX transceiver FPGAs—up to 531,200 LEs, 27,376 Kb RAM, 1,288 18 x 18-bit multipliers, and 48 full-duplex clock data recovery (CDR)-based transceivers at up to 8.5 Gbps
- Stratix IV GT—up to 531,200 LEs, 27,376 Kb RAM, 1,288 18 x 18-bit multipliers, and 48 full-duplex CDR-based transceivers at up to 11.3 Gbps

The complete Altera high-end solution includes the lowest risk, lowest total cost path to volume using HardCopy® IV ASICs for all the family variants, a comprehensive portfolio of application solutions customized for end-markets, and the industry leading Quartus® II software to increase productivity and performance.

- For information about upcoming Stratix IV device features, refer to the *Upcoming Stratix IV Device Features* document.
- For information about changes to the currently published *Stratix IV Device Handbook*, refer to the *Addendum to the Stratix IV Device Handbook* chapter.

This chapter contains the following sections:

- "Feature Summary" on page 1–2
- "Architecture Features" on page 1–6
- "Integrated Software Platform" on page 1–19
- "Ordering Information" on page 1–19

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Feature Summary

The following list summarizes the Stratix IV device family features:

- Up to 48 full-duplex CDR-based transceivers in Stratix IV GX and GT devices supporting data rates up to 8.5 Gbps and 11.3 Gbps, respectively
- Dedicated circuitry to support physical layer functionality for popular serial protocols, such as PCI Express (PCIe) (PIPE) Gen1 and Gen2, Gbps Ethernet (GbE), Serial RapidIO, SONET/SDH, XAUI/HiGig, (OIF) CEI-6G, SD/HD/3G-SDI, Fibre Channel, SFI-5, and Interlaken
- Complete PCIe protocol solution with embedded PCIe hard IP blocks that implement PHY-MAC layer, Data Link layer, and Transaction layer functionality
 - For more information, refer to the *IP Compiler for PCI Express User Guide*.
- Programmable transmitter pre-emphasis and receiver equalization circuitry to compensate for frequency-dependent losses in the physical medium
- Typical physical medium attachment (PMA) power consumption of 100 mW at 3.125 Gbps and 135 mW at 6.375 Gbps per channel
- 72,600 to 813,050 equivalent LEs per device
- 7,370 to 33,294 Kb of enhanced TriMatrix memory consisting of three RAM block sizes to implement true dual-port memory and FIFO buffers
- High-speed digital signal processing (DSP) blocks configurable as 9 x 9-bit, 12 x 12-bit, 18 x 18-bit, and 36 x 36-bit full-precision multipliers at up to 600 MHz
- Up to 16 global clocks (GCLK), 88 regional clocks (RCLK), and 132 periphery clocks (PCLK) per device
- Programmable power technology that minimizes power while maximizing device performance
- Up to 1,120 user I/O pins arranged in 24 modular I/O banks that support a wide range of single-ended and differential I/O standards
- Support for high-speed external memory interfaces including DDR, DDR2, DDR3 SDRAM, RLDRAM II, QDR II, and QDR II+ SRAM on up to 24 modular I/O banks
- High-speed LVDS I/O support with serializer/deserializer (SERDES), dynamic phase alignment (DPA), and soft-CDR circuitry at data rates up to 1.6 Gbps
- Support for source-synchronous bus standards, including SGMII, GbE, SPI-4 Phase 2 (POS-PHY Level 4), SFI-4.1, XSBI, UTOPIA IV, NPSI, and CSIX-L1
- Pinouts for Stratix IV E devices designed to allow migration of designs from Stratix III to Stratix IV E with minimal PCB impact

Stratix IV GX Devices

Stratix IV GX devices provide up to 48 full-duplex CDR-based transceiver channels per device:

- Thirty-two out of the 48 transceiver channels have dedicated physical coding sublayer (PCS) and physical medium attachment (PMA) circuitry and support data rates between 600 Mbps and 8.5 Gbps
- The remaining 16 transceiver channels have dedicated PMA-only circuitry and support data rates between 600 Mbps and 6.5 Gbps
- The actual number of transceiver channels per device varies with device selection. For more information about the exact transceiver count in each device, refer to Table 1–1 on page 1–11.
- For more information about transceiver architecture, refer to the *Transceiver Architecture in Stratix IV Devices* chapter.

Figure 1–1 shows a high-level Stratix IV GX chip view.

General Purpose General Purpose PLL PLL I/O and Memory I/O and Memory Interface Interface PLL Transceive Transceive PCI Express Hard IP Block Block Block PCI Express Hard IP Transceiver **Transceiver FPGA Fabric** (Logic Elements, DSP, Embedded Memory, PLL ransceiver | Transceiver Transceiver Clock Networks) Block Block PCI Express Hard IP Block Block Hard IP ansceiver Block Block PLL General Purpose General Purpose PLL PLL I/O and Memory I/O and Memory Interface Interface Transceiver Block 600 Mbps-8.5 Gbps CDR-based Transceiver General Purpose I/O and General Purpose I/O and 150 Mbps-1.6 Gbps High-Speed LVDS I/O LVDS interface with DPA and Soft-CDR

Figure 1–1. Stratix IV GX Chip View (1)

Note to Figure 1–1:

(1) Resource counts vary with device selection, package selection, or both.

with DPA and Soft CDR

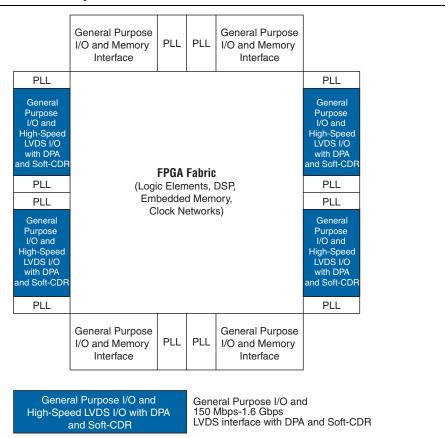
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Stratix IV E Device

Stratix IV E devices provide an excellent solution for applications that do not require high-speed CDR-based transceivers, but are logic, user I/O, or memory intensive.

Figure 1–2 shows a high-level Stratix IV E chip view.

Figure 1–2. Stratix IV E Chip View (1)



Note to Figure 1-2:

(1) Resource counts vary with device selection, package selection, or both.

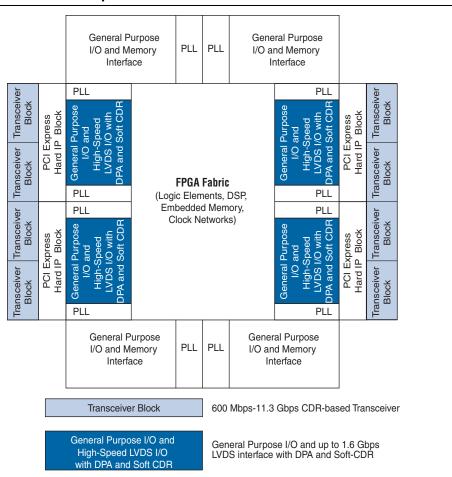
Stratix IV GT Devices

Stratix IV GT devices provide up to 48 CDR-based transceiver channels per device:

- Thirty-two out of the 48 transceiver channels have dedicated PCS and PMA circuitry and support data rates between 600 Mbps and 11.3 Gbps
- The remaining 16 transceiver channels have dedicated PMA-only circuitry and support data rates between 600 Mbps and 6.5 Gbps
- The actual number of transceiver channels per device varies with device selection. For more information about the exact transceiver count in each device, refer to Table 1–7 on page 1–16.
- For more information about Stratix IV GT devices and transceiver architecture, refer to the *Transceiver Architecture in Stratix IV Devices* chapter.

Figure 1–3 shows a high-level Stratix IV GT chip view.

Figure 1-3. Stratix IV GT Chip View (1)



Note to Figure 1-3:

(1) Resource counts vary with device selection, package selection, or both.

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Architecture Features

The Stratix IV device family features are divided into high-speed transceiver features and FPGA fabric and I/O features.



The high-speed transceiver features apply only to Stratix IV GX and Stratix IV GT devices.

High-Speed Transceiver Features

The following sections describe high-speed transceiver features for Stratix IV GX and GT devices.

Highest Aggregate Data Bandwidth

Up to 48 full-duplex transceiver channels supporting data rates up to 8.5 Gbps in Stratix IV GX devices and up to 11.3 Gbps in Stratix IV GT devices.

Wide Range of Protocol Support

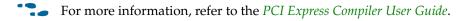
Physical layer support for the following serial protocols:

- Stratix IV GX—PCIe Gen1 and Gen2, GbE, Serial RapidIO, SONET/SDH, XAUI/HiGig, (OIF) CEI-6G, SD/HD/3G-SDI, Fibre Channel, SFI-5, GPON, SAS/SATA, HyperTransport 1.0 and 3.0, and Interlaken
- Stratix IV GT—40G/100G Ethernet, SFI-S, Interlaken, SFI-5.1, Serial RapidIO, SONET/SDH, XAUI/HiGig, (OIF) CEI-6G, 3G-SDI, and Fibre Channel
- Extremely flexible and easy-to-configure transceiver data path to implement proprietary protocols
- PCIe Support
 - Complete PCIe Gen1 and Gen2 protocol stack solution compliant to PCI Express base specification 2.0 that includes PHY-MAC, Data Link, and transaction layer circuitry embedded in PCI Express hard IP blocks
 - For more information, refer to the *PCI Express Compiler User Guide*.
 - Root complex and end-point applications
 - x1, x4, and x8 lane configurations
 - PIPE 2.0-compliant interface
 - Embedded circuitry to switch between Gen1 and Gen2 data rates
 - Built-in circuitry for electrical idle generation and detection, receiver detect, power state transitions, lane reversal, and polarity inversion
 - 8B/10B encoder and decoder, receiver synchronization state machine, and
 ± 300 parts per million (ppm) clock compensation circuitry
 - Transaction layer support for up to two virtual channels (VCs)

- XAUI/HiGig Support
 - Compliant to IEEE802.3ae specification
 - Embedded state machine circuitry to convert XGMII idle code groups (| |I| |) to and from idle ordered sets (| |A| |, | |K| |, | |R| |) at the transmitter and receiver, respectively
 - 8B/10B encoder and decoder, receiver synchronization state machine, lane deskew, and \pm 100 ppm clock compensation circuitry
- GbE Support
 - Compliant to IEEE802.3-2005 specification
 - Automatic idle ordered set (/I1/, /I2/) generation at the transmitter, depending on the current running disparity
 - 8B/10B encoder and decoder, receiver synchronization state machine, and
 ± 100 ppm clock compensation circuitry
- Support for other protocol features such as MSB-to-LSB transmission in SONET/SDH configuration and spread-spectrum clocking in PCIe configurations

Diagnostic Features

- Serial loopback from the transmitter serializer to the receiver CDR for transceiver PCS and PMA diagnostics
- Reverse serial loopback pre- and post-CDR to transmitter buffer for physical link diagnostics
- Loopback master and slave capability in PCI Express hard IP blocks



Signal Integrity

Stratix IV devices simplify the challenge of signal integrity through a number of chip, package, and board-level enhancements to enable efficient high-speed data transfer into and out of the device. These enhancements include:

- Programmable 3-tap transmitter pre-emphasis with up to 8,192 pre-emphasis levels to compensate for pre-cursor and post-cursor inter-symbol interference (ISI)
- Up to 900% boost capability on the first pre-emphasis post-tap
- User-controlled and adaptive 4-stage receiver equalization with up to 16 dB of high-frequency gain
- On-die power supply regulators for transmitter and receiver phase-locked loop (PLL) charge pump and voltage controlled oscillator (VCO) for superior noise immunity
- On-package and on-chip power supply decoupling to satisfy transient current requirements at higher frequencies, thereby reducing the need for on-board decoupling capacitors
- Calibration circuitry for transmitter and receiver on-chip termination (OCT) resistors

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FPGA Fabric and I/O Features

The following sections describe the Stratix IV FPGA fabric and I/O features.

Device Core Features

- Up to 531,200 LEs in Stratix IV GX and GT devices and up to 813,050 LEs in Stratix IV E devices, efficiently packed in unique and innovative adaptive logic modules (ALMs)
- Ten ALMs per logic array block (LAB) deliver faster performance, improved logic utilization, and optimized routing
- Programmable power technology, including a variety of process, circuit, and architecture optimizations and innovations
- Programmable power technology available to select power-driven compilation options for reduced static power consumption

Embedded Memory

- TriMatrix embedded memory architecture provides three different memory block sizes to efficiently address the needs of diversified FPGA designs:
 - 640-bit MLAB
 - 9-Kb M9K
 - 144-Kb M144K
- Up to 33,294 Kb of embedded memory operating at up to 600 MHz
- Each memory block is independently configurable to be a single- or dual-port RAM, FIFO, ROM, or shift register

Digital Signal Processing (DSP) Blocks

- Flexible DSP blocks configurable as 9 x 9-bit, 12 x 12-bit, 18 x 18-bit, and 36 x 36-bit full-precision multipliers at up to 600 MHz with rounding and saturation capabilities
- Faster operation due to fully pipelined architecture and built-in addition, subtraction, and accumulation units to combine multiplication results
- Optimally designed to support advanced features such as adaptive filtering, barrel shifters, and finite and infinite impulse response (FIR and IIR) filters

Clock Networks

- Up to 16 global clocks and 88 regional clocks optimally routed to meet the maximum performance of 800 MHz
- Up to 112 and 132 periphery clocks in Stratix IV GX and Stratix IV E devices, respectively
- Up to 66 (16 GCLK + 22 RCLK + 28 PCLK) clock networks per device quadrant in Stratix IV GX and Stratix IV GT devices
- Up to 71 (16 GCLK + 22 RCLK + 33 PCLK) clock networks per device quadrant in Stratix IV E devices

PLLs

- Three to 12 PLLs per device supporting spread-spectrum input tracking, programmable bandwidth, clock switchover, dynamic reconfiguration, and delay compensation
- On-chip PLL power supply regulators to minimize noise coupling

I/O Features

- Sixteen to 24 modular I/O banks per device with 24 to 48 I/Os per bank designed and packaged for optimal simultaneous switching noise (SSN) performance and migration capability
- Support for a wide range of industry I/O standards, including single-ended (LVTTL/CMOS/PCI/PCIX), differential (LVDS/mini-LVDS/RSDS), voltage-referenced single-ended and differential (SSTL/HSTL Class I/II) I/O standards
- On-chip series (R_S) and on-chip parallel (R_T) termination with auto-calibration for single-ended I/Os and on-chip differential (R_D) termination for differential I/Os
- Programmable output drive strength, slew rate control, bus hold, and weak pull-up capability for single-ended I/Os
- User I/O:GND:V_{CC} ratio of 8:1:1 to reduce loop inductance in the package—PCB interface
- Programmable transmitter differential output voltage (V_{OD}) and pre-emphasis for high-speed LVDS I/O

High-Speed Differential I/O with DPA and Soft-CDR

- Dedicated circuitry on the left and right sides of the device to support differential links at data rates from 150 Mbps to 1.6 Gbps
- Up to 98 differential SERDES in Stratix IV GX devices, up to 132 differential SERDES in Stratix IV E devices, and up to 47 differential SERDES in Stratix IV GT devices
- DPA circuitry at the receiver automatically compensates for channel-to-channel and channel-to-clock skew in source synchronous interfaces
- Soft-CDR circuitry at the receiver allows implementation of asynchronous serial interfaces with embedded clocks at up to 1.6 Gbps data rate (SGMII and GbE)

External Memory Interfaces

- Support for existing and emerging memory interface standards such as DDR SDRAM, DDR2 SDRAM, DDR3 SDRAM, QDRII SRAM, QDRII+ SRAM, and RLDRAM II
- DDR3 up to 1,067 Mbps/533 MHz
- Programmable DQ group widths of 4 to 36 bits (includes parity bits)
- Dynamic OCT, trace mismatch compensation, read-write leveling, and half-rate register capabilities provide a robust external memory interface solution

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System Integration

- All Stratix IV devices support hot socketing
- Four configuration modes:
 - Passive Serial (PS)
 - Fast Passive Parallel (FPP)
 - Fast Active Serial (FAS)
 - JTAG configuration
- Ability to perform remote system upgrades
- 256-bit advanced encryption standard (AES) encryption of configuration bits protects your design against copying, reverse engineering, and tampering
- Built-in soft error detection for configuration RAM cells
- For more information about how to connect the PLL, external memory interfaces, I/O, high-speed differential I/O, power, and the JTAG pins to PCB, refer to the Stratix IV GX and Stratix IV E Device Family Pin Connection Guidelines and the Stratix IV GT Device Family Pin Connection Guidelines.

Table 1–1 lists the Stratix IV GX device features.

Table 1–1. Stratix IV GX Device Features (Part 1 of 2)

Feature	EP4S	GX70	EP	4SGX1	10	I	EP4SG	X180			EP4SG	X230			E	P4SG	X290					EP4S(GX360)		EP4S0	3X530
Package Option	F780	F1152	F780	E1159	70	F780	E1 1E2	76113	F1517	F780	E1 152	76113	F1517	F780	E11E2	70	F1517	F1760	F1932	F780	E4 4 E O	70112	F1517	F1760	F1932	F1760	F1932
ALMs	29,0	040	4	12,240			70,3	800	•		91,2	200	•		•	116,4	180	•	•			141	,440	•	•	212	480
LEs	72,6	600	1	05,600)		175,	750			228,0	000				291,2	200					353	,600			531	,200
0.6 Gbps- 8.5 Gbps Transceivers (PMA + PCS)	_	16	_	_	16	_	_	16	24	_	_	16	24	_	_	16	24	24	32	_	_	16	24	24	32	24	32
0.6 Gbps- 6.5 Gbps Transceivers (PMA + PCS)	8		8	16	_	8	16	_	_	8	16	_	_	16	16	_	_	_	_	16	16	_		_	_	_	_
PMA-only CMU Channels (0.6 Gbps- 6.5 Gbps)	-	8	_	_	8	_	_	8	12	_	_	8	12	_	_	8	12	12	16	_	_	8	12	12	16	12	16
PCI Express hard IP Blocks	1	2	1	2		1		2		1		2				2			4			2			4	2	1
High-Speed LVDS SERDES (up to 1.6 Gbps)	28	56	28	28	56	28	4	4	88	28	4-	4	88	_	44	4	88	88	98	_	4	4	88	88	98	88	98
SPI-4.2 Links	1			1		1	2	2	4	1	2	2	4	_	2)		4		_	2	2		4		4	1

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Table 1–1. Stratix IV GX Device Features (Part 2 of 2)

Feature	EP4S0	GX70	EP	4SGX1	10	Е	P4SG	X180			EP4SG	X230			E	P4SG	X290				ı	EP4S(GX360)		EP4S0	X530
Package Option	F780	F1152	F780	F1152		F780	F1152	76	F1517	F780	E44E9	102	F1517	F780	F1152	5	F1517	F1760	F1932	F780	F1152	7	F1517	F1760	F1932	F1760	F1932
M9K Blocks (256 x 36 bits)	46	2		660			950	0			1,2	35				936	6	<u>I</u>	<u>I</u>		•	1,2	248	<u>I</u>		1,2	80
M144K Blocks (2048 x 72 bits)	16	6		16			20)			22	2				36	1					4	8			6	4
Total Memory (MLAB+M9K +M144K) Kb	7,3	70		9,564			13,6	27			17,1	33				17,2	48					22,	564			27,	376
Embedded Multipliers 18 x 18 (2)	38	34		512			920	0			1,28	88				832	2				1	,040			1,02 4	1,0	124
PLLs	3	4	3	4		3	6	j	8	3	6	5	8	4	6		8	12	12	4	6	j	8	12	12	12	12
User I/Os (3)	372	488	372	372	48 8	372	56 4	56 4	74 4	372	564	56 4	74 4	289	564	56 4	74 4	88 0	92 0	289	564	56 4	74 4	88 0	920	880	920
Speed Grade (fastest to slowest) ⁽⁵⁾	-2×, -3, -4	-2, -3, -4	-2× , -3, -4	-2× , -3, -4	-2, -3, -4	-2× , -3, -4	-2 ×, -3, -4	-2 , -3 , -4	-2, -3, -4	-2× , -3, -4	-2× , -3, -4	-2, -3, -4	-2, -3, -4	-2× , -3, -4	-2× , -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2× , -3, -4	-2× , -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4

Notes to Table 1-1:

- (1) The total number of transceivers is divided equally between the left and right side of each device, except for the devices in the F780 package. These devices have eight transceiver channels located only on the right side of the device.
- (2) Four multiplier adder mode.
- (3) The user I/Os count from pin-out files includes all general purpose I/O, dedicated clock pins, and dual purpose configuration pins. Transceiver pins and dedicated configuration pins are not included in the pin count.
- (4) Total pairs of high-speed LVDS SERDES take the lowest channel count of R_x/T_x.
- (5) The difference between the Stratix IV GX devices in the -2 and -2x speed grades is the number of available transceiver channels. The -2 device allows you to use the transceiver CMU blocks as transceiver channels. In addition to the reduction of available transceiver channels in the Stratix IV GX -2x device, the data rates in the -2x device are limited to 6.5 Gbps.

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Table 1–2 lists the Stratix IV GX device package options.

Table 1–2. Stratix IV GX Device Package Options (1), (2)

Device			'80 29 mm) ⁽⁶⁾	(35	F1152 mm x 35 mm)		152 5 mm) ⁽⁵⁾ , ⁽⁷⁾	(4	F1517 40 mm x 40 mm) (5), (7)	(42.5	F1760 mm x 42.5 mm)	(45	F1932 mm x 45 mm)
EP4SGX70	\blacktriangle	DF29	_		_	▲ HF35	_		_		_		_
EP4SGX110		DF29	_	A	FF35	▼ HF35	_		_		_		_
EP4SGX180		DF29	_		FF35	_	▲ HF35	4	KF40		_		_
EP4SGX230	V	DF29	_		FF35	_	HF35		KF40		_		_
EP4SGX290		_	FH29 (3)		FF35	_	HF35		KF40		KF43		NF45
EP4SGX360		_	FH29 (3)	V	FF35	_	HF35		KF40		KF43		NF45
EP4SGX530		_	_		_	_	▼ HH35 (4)		KH40 ⁽⁴⁾	1	KF43		NF45

Notes to Table 1-2:

- (1) Device packages in the same column and marked under the same arrow sign have vertical migration capability.
- (2) Use the Pin Migration Viewer in the Pin Planner to verify the pin migration compatibility when migrating devices. For more information, refer to 1/O Management in the Quartus II Handbook, Volume 2.
- (3) The 780-pin EP4SGX290 and EP4SGX360 devices are available only in 33 mm x 33 mm Hybrid flip chip package.
- (4) The 1152-pin and 1517-pin EP4SGX530 devices are available only in 42.5 mm x 42.5 mm Hybrid flip chip packages.
- (5) When migrating between hybrid and flip chip packages, there is an additional keep-out area. For more information, refer to the Package Information Datasheet for Altera Devices.
- (6) Devices listed in this column are available in -2x, -3, and -4 speed grades. These devices do not have on-package decoupling capacitors.
- (7) Devices listed in this column are available in -2, -3, and -4 speed grades. These devices have on-package decoupling capacitors. For more information about on-package decoupling capacitor value in each device, refer to Table 1-3.



On-package decoupling reduces the need for on-board or PCB decoupling capacitors by satisfying the transient current requirements at higher frequencies. The *Power Delivery Network* design tool for Stratix IV devices accounts for the on-package decoupling and reflects the reduced requirements for PCB decoupling capacitors.

Table 1–3 lists the Stratix IV GX device on-package decoupling information.

Table 1–3. Stratix IV GX Device On-Package Decoupling Information (1)

Ordering Info	ormation	V _{CC}	V _{CCIO}	V _{CCL_GXB}	V _{CCA_L/R}	V _{CCT} and V _{CCR} (Shared)
EP4SGX70	HF35	2×1uF + 2×470nF	10nF per bank ⁽²⁾	100nF per transceiver block	100nF	1×470nF + 1×47nF per side
EP4SGX110	HF35	2×1uF + 2×470nF	10nF per bank ⁽²⁾	100nF per transceiver block	100nF	1×470nF + 1×47nF per side
EP4SGX180	HF35	2×1uF + 2×470nF	10nF per bank ⁽²⁾	100nF per transceiver block	100nF	1×470nF + 1×47nF per side
LF43GX100	KF40	2×101 + 2×470111	Tonir per bank (=/	TOUTH PET TRAITSCEIVER DIOCK	100111	1×470III + 1×47III pei siue
EP4SGX230	HF35	2×1 uF + 2×470 nF	10 nF per bank ⁽²⁾	100 nF per transceiver block	100 nF	1×470 nF + 1×47 nF
LF43GA230	KF40	2×1 ur + 2×4/0 III	TO HE per bank	100 III pei tialisceivei biock	100 111	per side
	HF35					
EP4SGX290	KF40	4×1 uF + 4×470 nF	10 nF per bank ⁽²⁾	100 nF per transceiver block	100nF	1×470 nF + 1×47 nF
LI 430X290	KF43	4×1 ul + 4×4/0 lll	TO THE PET DATIK 17	100 III pei tialiscelvei block	100111	per side
	NF45					
	HF35					
EP4SGX360	KF40	4×1 uF + 4×470 nF	10 nF per bank ⁽²⁾	100 nF per transceiver block	100 nF	1×470 nF + 1×47 nF
LI 430X300	KF43	4×1 ul + 4×4/0 lll	TO THE PET DATIK (=)	100 III pei tialiscelvei block	100 111	per side
	NF45					
	HH35					
EP4SGX530	KH40	4×1 uF + 4×470 nF	10 nF per bank ⁽²⁾	100 nF per transceiver block	100 nF	1×470 nF + 1×47 nF
EF43GA330	KF43	4×1 ur + 4×4/0 IIF	TO THE PET DATIK	100 III pei tialiscelvei biock	100 116	per side
	NF45					

Notes to Table 1-3:

- (1) Table 1-3 refers to production devices on-package decoupling. For more information about decoupling design of engineering sample (ES) devices, contact Altera Technical Support.
- (2) For I/O banks 3(*), 4(*), 7(*), and 8(*) only. There is no OPD for I/O bank 1(*), 2(*), 5(*), and 6(*).

Table 1-4. Stratix IV E Device Features

Feature	EP4SE230	EP4	SE360		EP4SE530			EP4SE820			
Package Pin Count	780	780	1152	1152	1517	1760	1152	1517	1760		
ALMs	91,200	141	1,440		212,480		325,220				
LEs	228,000	353	3,600		531,200			813,050			
High-Speed LVDS SERDES (up to 1.6 Gbps) ⁽¹⁾	56	56	88	88	112	112	88	112	132		
SPI-4.2 Links	3	3	4	4		6	4	6	6		
M9K Blocks (256 x 36 bits)	1,235	1,	248		1,280			1610			
M144K Blocks (2048 x 72 bits)	22	4	48		64			60			
Total Memory (MLAB+M9K+ M144K) Kb	17,133	22	,564		27,376			33,294			
Embedded Multipliers (18 x 18) (2)	1,288	1,	040		1,024			960			
PLLs	4	4	8	8	12	12	8	12	12		
User I/Os (3)	488	488	744	744	976	976	744 (4)	976 ⁽⁴⁾	1120 ⁽⁴⁾		
Speed Grade (fastest to slowest)	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-2, -3, -4	-3, -4	-3, -4	-3, -4		

Notes to Table 1-4:

- (1) The user I/O count from the pin-out files include all general purpose I/Os, dedicated clock pins, and dual purpose configuration pins. Transceiver pins and dedicated configuration pins are not included in the pin count.
- (2) Four multiplier adder mode.
- (3) Total pairs of high-speed LVDS SERDES take the lowest channel count of R_X/T_X .
- (4) This data is preliminary.

Table 1–5. Stratix IV E Device Package Options (1), (2)

Device	F780 (29 mm x 29 mm) ⁽⁵⁾ , ⁽⁶⁾	F1152 (35 mm x 35 mm) ⁽⁵⁾ , ⁽⁷⁾	F1517 (40 mm x 40 mm) ⁽⁷⁾	F1760 (42.5 mm x 42.5 mm) ⁽⁷⁾
EP4SE230	▲ F29	_	_	_
EP4SE360	▼ H29 ⁽³⁾	▲ F35	_	_
EP4SE530	_	H35 ⁽⁴⁾	▲ H40 ⁽⁴⁾	▲ F43
EP4SE820		H35 ⁽⁴⁾	H40 ⁽⁴⁾	▼ F43

Notes to Table 1-5:

- (1) Device packages in the same column and marked under the same arrow sign have vertical migration capability.
- (2) Use the Pin Migration Viewer in the Pin Planner to verify the pin migration compatibility when migrating devices. For more information, refer to *I/O Management* in the *Quartus II Handbook, Volume 2*.
- (3) The 780-pin EP4SE360 device is available only in the 33 mm x 33 mm Hybrid flip chip package.
- (4) The 1152-pin and 1517-pin for EP4SE530 and EP4SE820 devices are available only in the 42.5 mm x 42.5 mm Hybrid flip chip package.
- (5) When migrating between hybrid and flip chip packages, there is an additional keep-out area. For more information, refer to the *Package Information Datasheet for Altera Devices*.
- (6) Devices listed in this column do not have on-package decoupling capacitors.
- (7) Devices listed in this column have on-package decoupling capacitors. For more information about on-package decoupling capacitor value for each device, refer to Table 1–6.

Table 1–6 lists the Stratix IV E on-package decoupling information.

Table 1–6. Stratix IV E Device On-Package Decoupling Information (1)

Ordering I	nformation	V _{CC}	V _{CCIO}
EP4SE360	F35	4×1 uF + 4×470 nF	10 nF per bank
	H35		
EP4SE530	H40	4×1 uF + 4×470 nF	10 nF per bank
	F43		
	H35		
EP4SE820	H40	4×1 uF + 4×470 nF	10 nF per bank
	F43		

Note to Table 1-6:

Table 1–7 lists the Stratix IV GT device features.

Table 1–7. Stratix IV GT Device Features (Part 1 of 2)

Feature	EP4S40G2	EP4\$40G5	EP4S100G2	EP4S100G3	EP4S100G4	EP4S	100G5
Package Pin Count	1517	1517	1517	1932	1932	1517	1932
ALMs	91,200	212,480	91,200	116,480	141,440	212	,480
LEs	228,000	531,200	228,000	291,200	353,600	531	,200
Total Transceiver Channels	36	36	36	48	48	36	48

⁽¹⁾ Table 1–6 refers to production devices on-package decoupling. For more information about decoupling design of engineering sample (ES) devices, contact Altera Technical Support.

Table 1-7. Stratix IV GT Device Features (Part 2 of 2)

Feature	EP4S40G2	EP4S40G5	EP4S100G2	EP4S100G3	EP4S100G4	EP4S	100G5
10G Transceiver Channels (600 Mbps - 11.3 Gbps with PMA + PCS)	12	12	24	24	24	24	32
8G Transceiver Channels (600 Mbps - 8.5 Gbps with PMA + PCS) (1)	12	12	0	8	8	0	0
PMA-only CMU Channels (600 Mbps- 6.5 Gbps)	12	12	12	16	16	12	16
PCIe hard IP Blocks	2	2	2	4	4	2	4
High-Speed LVDS SERDES (up to 1.6 Gbps) (2)	46	46	46	47	47	46	47
SP1-4.2 Links	2	2	2	2	2	2	2
M9K Blocks (256 x 36 bits)	1,235	1,280	1,235	936	1,248	1,2	280
M144K Blocks (2048 x 72 bits)	22	64	22	36	48	6	4
Total Memory (MLAB + M9K + M144K) Kb	17,133	27,376	17,133	17,248	22,564	27,	376
Embedded Multipliers 18 x 18 ⁽³⁾	1,288	1,024	1,288	832	1,024	1,0)24
PLLs	8	8	8	12	12	8	12
User I/Os (4), (5)	654	654	654	781	781	654	781
Speed Grade (fastest to slowest)	-1, -2, -3	-1, -2, -3	-1, -2, -3	-1, -2, -3	-1, -2, -3	-1, -2, -3	-1, -2, -3

Notes to Table 1-7:

- (1) You can configure all 10G transceiver channels as 8G transceiver channels. For example, the EP4S40G2F40 device has twenty-four 8G transceiver channels and the EP4S100G5F45 device has thirty-two 8G transceiver channels.
- (2) Total pairs of high-speed LVDS SERDES take the lowest channel count of R_X/T_X .
- (3) Four multiplier adder mode.
- (4) The user I/O count from the pin-out files include all general purpose I/Os, dedicated clock pins, and dual purpose configuration pins. Transceiver pins and dedicated configuration pins are not included in the pin count.
- (5) This data is preliminary.

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Table 1–8 lists the resource counts for the Stratix IV GT devices.

Table 1–8. Stratix IV GT Device Package Options (1), (2)

Device	1517 Pin (40 mm x 40 mm) ⁽³⁾	1932 Pin (45 mm x 45 mm)
Stratix IV GT 40 G Devices		
EP4S40G2	▲ F40	_
EP4S40G5	H40 ⁽⁴⁾ , ⁽⁵⁾	_
Stratix IV GT 100 G Devices		
EP4S100G2	▲ F40	_
EP4S100G3	_	▲ F45
EP4S100G4	_	F45
EP4S100G5	H40 ⁽⁴⁾ , ⁽⁵⁾	▼ F45

Notes to Table 1-8:

- (1) This table represents pin compatability; however, it does not include hard IP block placement compatability.
- (2) Devices under the same arrow sign have vertical migration capability.
- (3) When migrating between hybrid and flip chip packages, there is an additional keep-out area. For more information, refer to the Altera Device Package Information Data Sheet.
- (4) EP4S40G5 and EP4S100G5 devices with 1517 pin-count are only available in 42.5-mm x 42.5-mm Hybrid flip chip packages.
- (5) If you are using the hard IP block, migration is not possible.

Table 1–9 lists the Stratix IV GT on-package decoupling information.

Table 1–9. Stratix IV GT Device On-Package Decoupling Information (1)

Ordering Information	V _{CC}	V _{CCIO}	V _{CCL_GXB}	V _{CCA_L/R}	V _{CCT_L/R}	V _{CCR_L/R}
EP4S40G2F40	2×1 uF + 2×470 nF	10 nF per bank ⁽²⁾	100 nF per	100 nF	100 nF	100 nF
EP4S100G2F40	2×1 ur + 2×4/0 III	TO THE PET DATIK (=)	transceiver block	100 111	100 111	100 111
EP4S100G3F45						
EP4S100G4F45			400 -			
EP4S40G5H40	4×1 uF + 4×470 nF	10 nF per bank ⁽²⁾	100 nF per transceiver block	100 nF 100 nF	100 nF	100 nF
EP4S100G5H40			transcerver block			
EP4S100G5F45						

Notes to Table 1-9:

- (1) Table 1–9 refers to production devices on-package decoupling. For more information about decoupling design of engineering sample (ES) devices, contact Altera Technical Support.
- (2) For I/O banks 3(*), 4(*), 7(*), and 8(*) only. There is no OPD for I/O bank 1(*), 2(*), 5(*), and 6(*).

Integrated Software Platform

The Quartus II software provides an integrated environment for HDL and schematic design entry, compilation and logic synthesis, full simulation and advanced timing analysis, SignalTap II Logic Analyzer, and device configuration of Stratix IV designs. The Quartus II software provides the MegaWizard™ Plug-In Manager user interface to generate different functional blocks, such as memory, PLL, and digital signal processing logic. For transceivers, the Quartus II software provides the ALTGX MegaWizard Plug-In Manager interface that guides you through configuration of the transceiver based on your application requirements.

The Stratix IV GX and GT transceivers allow you to implement low-power and reliable high-speed serial interface applications with its fully reconfigurable hardware, optimal signal integrity, and integrated Quartus II software platform.

For more information about the Quartus II software features, refer to the Quartus II Handbook.

Ordering Information

This section describes the Stratix IV E, GT, and GX devices ordering information. Figure 1–4 shows the ordering codes for Stratix IV GX and E devices.

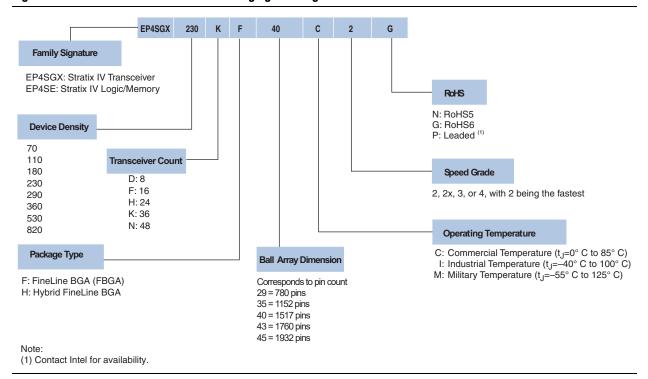
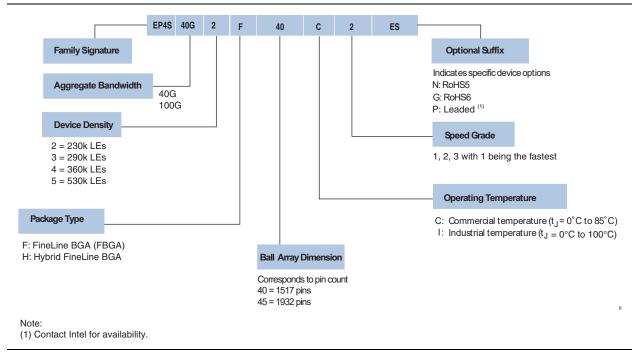


Figure 1–4. Stratix IV GX and E Device Packaging Ordering Information

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Figure 1–5 shows the ordering codes for Stratix IV GT devices.

Figure 1-5. Stratix IV GT Device Packaging Ordering Information



Document Revision History

Table 1–10 lists the revision history for this chapter.

Table 1–10. Document Revision History (Part 1 of 2)

Date	Version	Changes
luna 2020	2020.06.15	Updated ordering information to add the "P" optional suffix.
June 2020	2020.00.13	Removed the "ES" optional suffix from the ordering information.
January 2016	3.5	■ Updated Figure 1–4 with new RoHS information
Cantambar 2012	3.4	■ Updated Table 1–1 to close FB #30986.
September 2012	3.4	■ Updated Table 1–2 and Table 1–5 to close FB #31127.
June 2011	3.3	Added military temperature to Figure 1–4.
		■ Updated Table 1–7 and Table 1–8.
February 2011	3.2	Applied new template.
		Minor text edits.
		■ Updated Table 1–1, Table 1–2, and Table 1–7.
		■ Updated Figure 1–3.
March 2010	3.1	■ Updated the "Stratix IV GT Devices" section.
		Added two new references to the Introduction section.
	1	Minor text edits.

Table 1–10. Document Revision History (Part 2 of 2)

Date	Version	Changes
November 2009	3.0	Updated the "Stratix IV Device Family Overview", "Feature Summary", "Stratix IV GT Devices", "High-Speed Transceiver Features", "FPGA Fabric and I/O Features", "Highest Aggregate Data Bandwidth", "System Integration", and "Integrated Software Platform" sections.
		■ Added Table 1–3, Table 1–6, and Table 1–9.
		■ Updated Table 1–1, Table 1–2, Table 1–4, Table 1–5, Table 1–7, and Table 1–8.
		■ Updated Figure 1–3, Figure 1–4, and Figure 1–5.
		■ Minor text edits.
June 2009	2.4	■ Updated Table 1–1.
		■ Minor text edits.
April 2009	2.3	■ Added Table 1–5, Table 1–6, and Figure 1–3.
		■ Updated Figure 1–5.
		■ Updated Table 1–1, Table 1–2, Table 1–3, and Table 1–4.
		Updated "Introduction", "Feature Summary", "Stratix IV GX Devices", "Stratix IV GT Devices", "Architecture Features", and "FPGA Fabric and I/O Features"
March 2009	2.2	■ Updated "Feature Summary", "Stratix IV GX Devices", "Stratix IV E Device", "Stratix IV GT Devices", "Signal Integrity"
		Removed Tables 1-5 and 1-6
		■ Updated Figure 1–4
March 2009	2.1	Updated "Introduction", "Feature Summary", "Stratix IV Device Diagnostic Features", "Signal Integrity", "Clock Networks", "High-Speed Differential I/O with DPA and Soft-CDR", "System Integration", and "Ordering Information" sections.
		Added "Stratix IV GT 100G Devices" and "Stratix IV GT 100G Transceiver Bandwidth" sections.
		■ Updated Table 1–1, Table 1–2, Table 1–3, and Table 1–4.
		■ Added Table 1–5 and Table 1–6.
		■ Updated Figure 1–3 and Figure 1–4.
		■ Added Figure 1–5.
		Removed "Referenced Documents" section.
November 2008	2.0	■ Updated "Feature Summary" on page 1–1.
		■ Updated "Stratix IV Device Diagnostic Features" on page 1–7.
		■ Updated "FPGA Fabric and I/O Features" on page 1–8.
		■ Updated Table 1–1.
		■ Updated Table 1–2.
		■ Updated "Table 1–5 shows the total number of transceivers available in the Stratix IV GT Device." on page 1–15.
July 2008	1.1	Revised "Introduction".
May 2008	1.0	Initial release.

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Ordering Information

Mouser Electronics

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Intel:

EP4SGX290HF35C2N EP4SGX230FF35C2XN EP4SGX110DF29I4 EP4SGX290KF43C4 EP4SGX180HF35I4 EP4S40G5H40I2 EP4SGX360KF40C4 EP4SE820H35C3N EP4SGX230DF29I4 EP4S100G3F45I2 EP4SGX360FH29C4 EP4SE360F35I4N EP4S100G5F45I1 EP4SGX110FF35C4N EP4SGX360FF35C4 EP4SGX230KF40C2N EP4SGX530HH35C4 EP4SGX530KH40I3N EP4SGX180DF29I4 EP4SGX290KF43C2N EP4SE820H40I4 EP4SE360F35I3 EP4SE530F43I4N EP4SE820H40C4N EP4SE360H29I4N EP4SGX360KF43C4 EP4SGX70DF29I3N EP4SE530H40I4N EP4SGX530HH35I3N EP4SGX290KF40C2N EP4SGX360HF35C4 EP4SGX180FF35I4 EP4SGX290FH29C2XN EP4SGX180KF40I4 EP4SE230F29I4N EP4SE530H35I4N EP4SGX290FF35C2XN EP4S100G5H40I3 EP4SGX530NF45I3N EP4SGX530KF43C4 EP4SGX290NF45C4 EP4SGX230KF40I4 EP4SGX110FF35C3 EP4SGX360NF45C4 EP4SGX360KF43C2N EP4SGX110HF35I4 EP4SGX110DF29C4N EP4SGX530KF43I3N EP4SE530H35I3 EP4SGX230FF35C4N EP4SGX530HH35C2N EP4SE820F43I4 EP4SGX230KF40C4N EP4SGX70HF35I3N EP4SGX290NF45C2N EP4SE230F29I3 EP4SGX360FH29C2XN EP4SGX530KF43C2N EP4SGX290KF43I4 EP4S100G4F45I2N EP4SGX70HF35C4 EP4SGX360FH29I4 EP4SGX110HF35C3 EP4SGX360FF35C2XN EP4SE530H35C3N EP4SGX360HF35C2N EP4SGX110DF29C3 EP4SE360F35C3N EP4SGX230HF35I4 EP4SGX70DF29C3N EP4SGX110HF35C4N EP4SGX360NF45C2N EP4S100G5H40I2N EP4SGX530NF45C4 EP4SGX70DF29C4 EP4SGX530KH40C2N EP4SE230F29C3N EP4SGX180DF29C3 EP4SGX360NF45C3N EP4SGX290FH29I4 EP4SGX360KF40C2N EP4SE360H29I3 EP4SGX180HF35C4N EP4SGX230HF35I3N EP4SGX230DF29I3N EP4SE360H29C4N EP4S100G2F40I2N EP4SGX230DF29C4N EP4SGX290KF43C2 EP4SGX70HF35I3 EP4SGX180FF35I3N EP4SE360F35C4N EP4SE530H35C4N EP4SGX290FH29I3N EP4SE530H40I4 EP4SGX180FF35C4 EP4SGX290KF40C2 EP4S40G2F40I3N EP4SE530F43C4N EP4SGX180KF40C4N